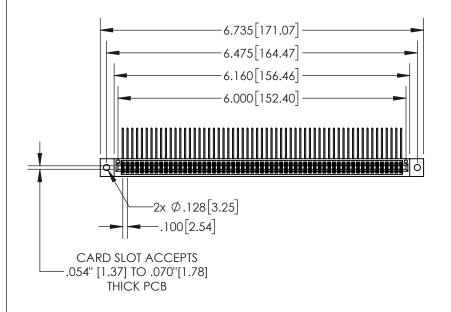
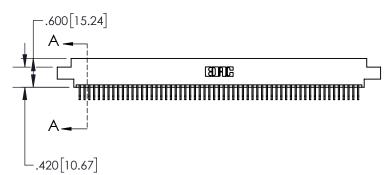
Contact Dimensions: 558-90 Degree Bend (Code 541 Contacts) See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions





.330[8.38] **CARD SLOT** .370 [9.40] **SECTION A-A** .160 4.06 POINT OF CONTACT −.200^[5.08]

- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY
 CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING
 ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SEI	RIES HIGH TEMF	CARD ED	GE CONNE	CTOR
PART NUME	BFR: 845-118-55	8-802		

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER				
DRAWN: R.STA.MONICA	DATE:MAY.16/2017			
CHECKED:	DATE:			
SCALE: 1:2	SHEET 1 OF 2			
DRAWING NUMBER	ISSUE			

845-ENG-MASTER







INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST

Contact Code 558

CONTACT MATERIAL; COPPER ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

Contact Code 559

	ACAD REFERENCE NO	. 845-ENG-MASTER
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017
	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

Contact Code 560

845-ENG-MASTER